

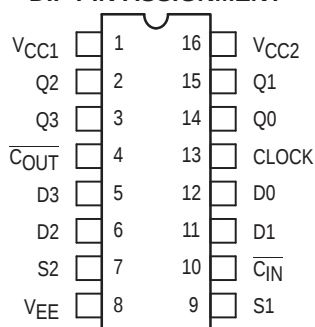
Universal Hexadecimal Counter

- Counting Frequency, 250 MHz Minimum
- Power Dissipation, 625 mW Typical
- Improved Noise Margin 150 mV
(Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

FUNCTION SELECT TABLE			
CIN	S1	S2	Operating Mode
X	L	L	Preset (Program)
L	L	H	Increment (Count Up)
H	L	H	Hold Count
L	H	L	Decrement (Count Down)
H	H	L	Hold Count
X	H	H	Hold (Stop Count)

INPUTS								OUTPUTS				
S1	S2	D0	D1	D2	D3	Carry In	Clock **	Q0	Q1	Q2	Q3	Carry Out
L	L	L	X	X	X	X	H	L	L	H	H	L
L	H	X	X	X	X	X	L	H	L	H	H	H
L	L	X	X	X	X	X	L	H	L	H	H	L
L	H	X	X	X	X	X	H	H	H	H	H	H
L	H	X	X	X	X	X	H	H	H	H	H	H
H	L	X	X	X	X	X	H	H	H	H	H	H
H	L	X	X	X	X	X	L	H	L	L	L	L
H	L	X	X	X	X	X	L	H	L	L	L	L
H	L	X	X	X	X	X	L	H	L	L	L	L
H	L	X	X	X	X	X	L	H	L	L	L	L

DIP PIN ASSIGNMENT



<http://onsemi.com>

Diagram of the MC10H136L AWLYYWW component, showing a 16-pin package with pins numbered 1 to 16.

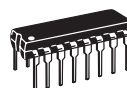


Diagram of the MC10H136P AWLYYWW chip, showing a 16-pin package with pins numbered 1 to 16.



Diagram of a component labeled 10H136 AWLYYWW. The component has 16 pins, numbered 1 to 16. Pin 1 is at the top center, and pin 16 is at the bottom center. The component is shown in a perspective view with a top surface and two side surfaces.

ORDERING INFORMATION

Device	Package	Shipping
MC10H136L	CDIP-16	25 Units/Rail
MC10H136P	PDIP-16	25 Units/Rail
MC10H136FN	PLCC-20	46 Units/Rail

MC10H136

MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply ($V_{CC} = 0$)	-8.0 to 0	Vdc
V_I	Input Voltage ($V_{CC} = 0$)	0 to V_{EE}	Vdc
I_{out}	Output Current – Continuous – Surge	50 100	mA
T_A	Operating Temperature Range	0 to +75	°C
T_{stg}	Storage Temperature Range – Plastic – Ceramic	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 \text{ V} \pm 5\%$) (See Note 1.)

Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
I_E	Power Supply Current	–	165	–	150	–	165	mA
I_{inH}	Input Current High Pins 5, 6, 11, 12, 13	–	430	–	275	–	275	μA
	Pin 9	–	670	–	420	–	420	
	Pin 7	–	535	–	335	–	335	
	Pin 10	–	380	–	240	–	240	
I_{inL}	Input Current Low	0.5	–	0.5	–	0.3	–	μA
V_{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V_{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V_{IH}	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V_{IL}	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

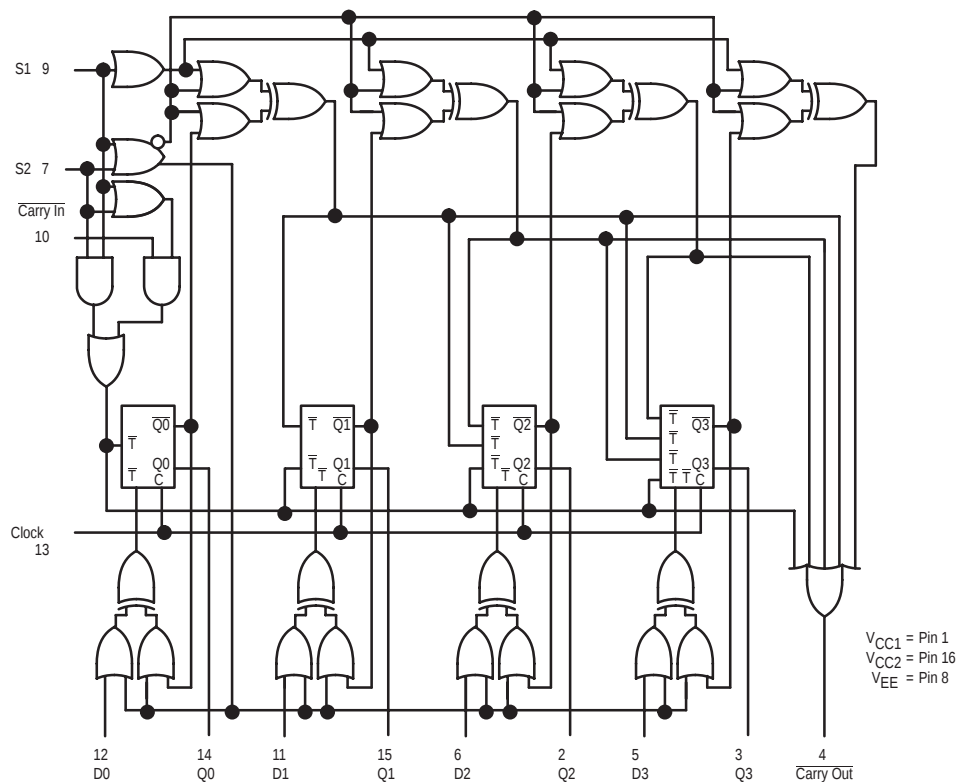
AC PARAMETERS

t_{pd}	Propagation Delay Clock to Q	0.7	2.3	0.7	2.4	0.7	2.5	ns
	Clock to Carry Out	1.0	4.8	1.0	4.9	1.0	5.0	
	Carry in to Carry Out	0.7	2.5	0.7	2.6	0.7	2.7	
t_{set}	Set-up Time Data (D0 to C)	2.0	–	2.0	–	2.0	–	ns
	Select (S to C)	3.5	–	3.5	–	3.5	–	
	Carry In (C_{in} to C)	2.0	–	2.0	–	2.0	–	
	(C to C_{in})	0	–	0	–	0	–	
t_{hold}	Hold Time Data (C to D0)	0	–	0	–	0	–	ns
	Select (C to S)	-0.5	–	-0.5	–	-0.5	–	
	Carry In (C to C_{in})	0	–	0	–	0	–	
	(C_{in} to C)	2.2	–	2.2	–	2.2	–	
f_{count}	Counting Frequency	250	–	250	–	250	–	MHz
t_r	Rise Time	0.5	2.3	0.5	2.4	0.5	2.5	ns
t_f	Fall Time	0.5	2.3	0.5	2.4	0.5	2.5	ns

- Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

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LOGIC DIAGRAM



NOTE: FLIP-FLOPS WILL TOGGLE WHEN ALL $\bar{T}$ INPUTS ARE LOW.

APPLICATION INFORMATION

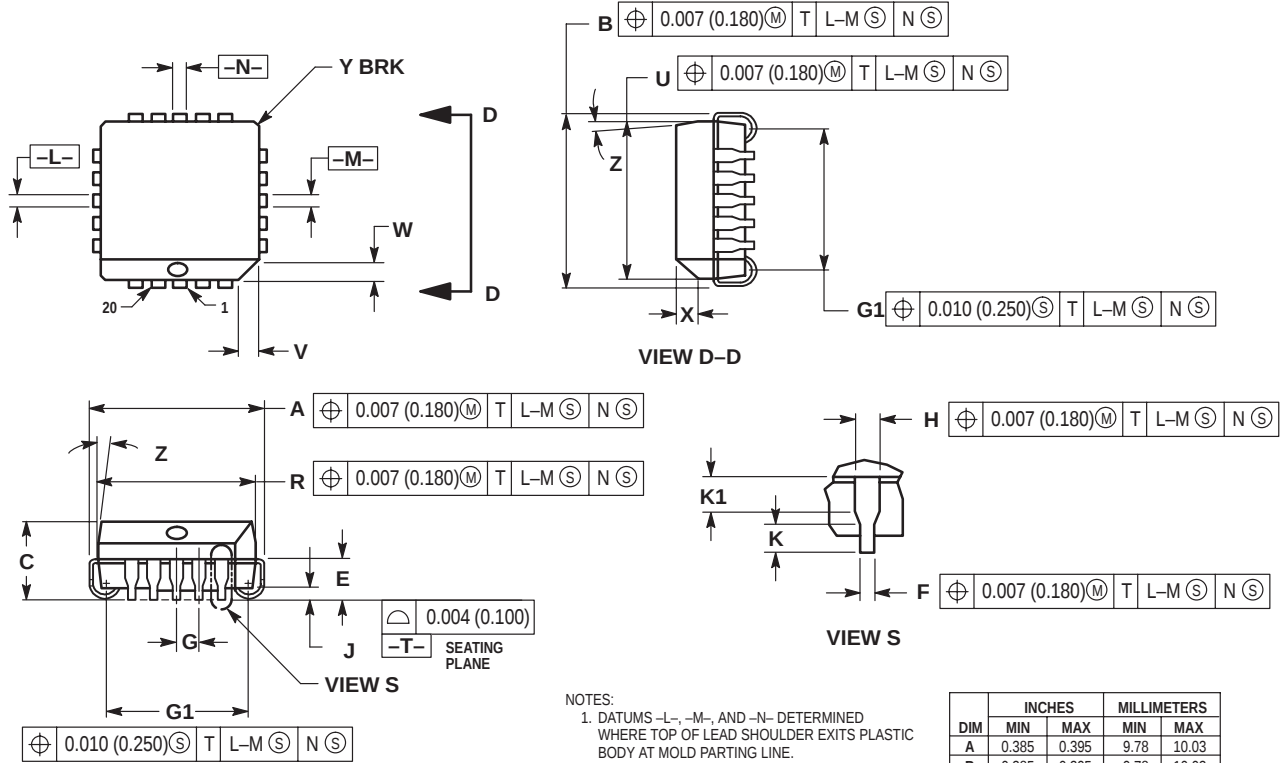
The MC10H136 is a high speed synchronous counter that operates at 250 MHz. Counter operating modes include count up, count down, pre-set and hold count. This device allows the designer to use one basic counter for many applications.

The S1, S2, control lines determine the operating modes of the counter. In the pre-set mode, a clock pulse is necessary to load the counter with the information present on the data inputs (D0, D1, D2, and D3). Carry out goes low on the terminal count or when the counter is being pre-set.

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PACKAGE DIMENSIONS

PLCC-20
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775-02
ISSUE C



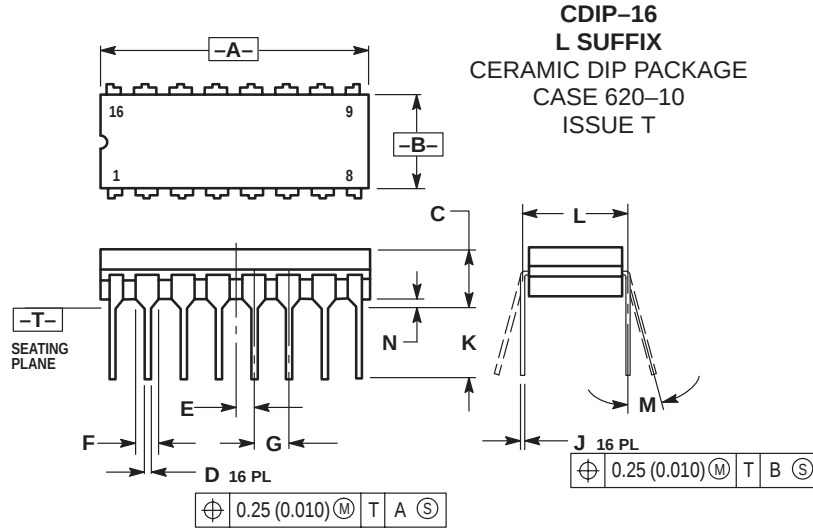
NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC	1.27 BSC		
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	—	1.02	—

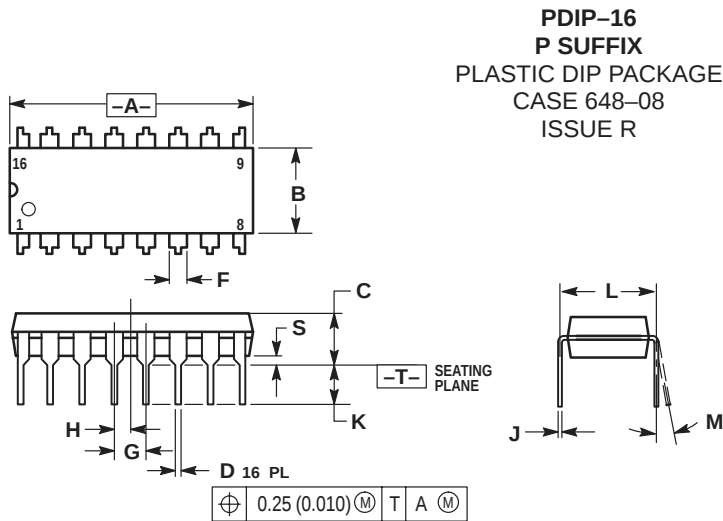
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PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

Notes

Notes

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JAPAN: ON Semiconductor, Japan Customer Focus Center
4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-8549

Phone: 81-3-5740-2745
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